



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: **IJIMA, et al.**

Serial No.: **09/466,895**

Group Art Unit: **3729**

Filed: **December 20, 1999**

Examiner: **Rick Kiltae Chang**

P.T.O. Confirmation No.: **1709**

For: **A METHOD FOR FABRICATING A WIRING SUBSTRATE BY ELECTROPLATING A WIRING FILM ON A METAL BASE (As Amended)**

AMENDMENT UNDER 37 CFR §1.111

Commissioner for Patents
Washington, D.C. 20231

November 27, 2002

Sir:

In response to the Office Action dated **August 29, 2002**, please amend the above-identified application as follows:

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TECHNOLOGY CENTER R3700

IN THE TITLE:

Please amend the title of the invention, in its entirety, so as to read as follows:

A METHOD FOR FABRICATING A WIRING SUBSTRATE BY ELECTROPLATING A WIRING FILM ON A METAL BASE

IN THE ABSTRACT:

Please delete the current Abstract and replace therewith the attached substitute

Abstract.

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